

HSF

NOTES:

- 1.Current Rating:3.0A(22#AWG) ;
- 2.Contact Resistance: 20mΩ Max;
- 3.Operating Temperature: -25℃ to +85℃;
- 4.Contact Material:Copper Alloy;
- 5.Contact plating:
80μ" TIN on solder area,
50μ" Nickel underplating overall;
- 6.Retention force:1 Kgf Min;
- 7.Applicable Wire
Conductor Sizes: SEE Table1;
Insulation O.D.: SEE Table1.

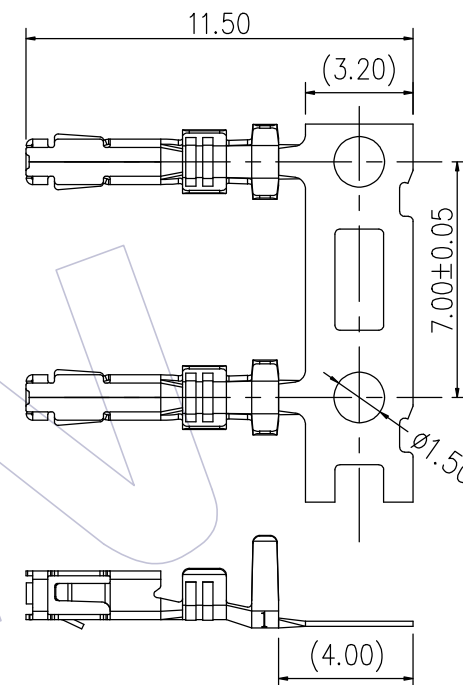
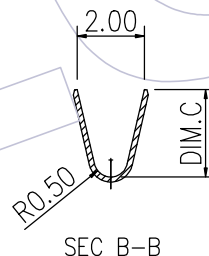
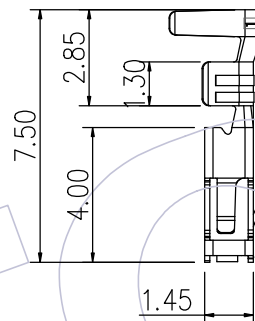
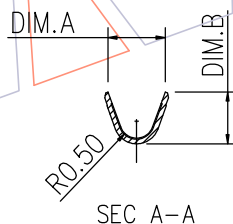
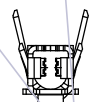
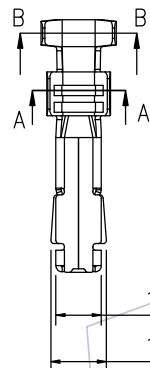
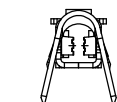
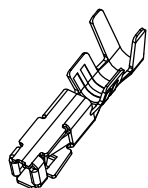
Ordering Information

WF2013 -T P SN XX

Material: _____
P=Phosphor Bronze

Plating: _____
SN=Bright Tin

Type: _____
See Table1



料带图 SCALE 1:1

Packing direction

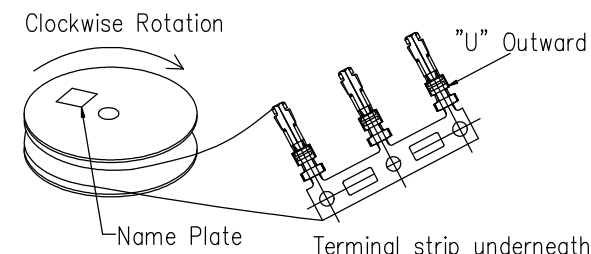


Table 1:

WF2013-TPSN02	1.40	1.24	2.45	24~28#AWG	φ0.76~1.5
WF2013-TPSN01	1.70	1.54	2.75	22~26#AWG	φ0.95~1.5
P/N	DIM.A	DIM.B	DIM.C	Conductor Sizes	Insulation O.D

				OPERATION		DRAW YZJ	DATE 2023/03/06	SCALE	FIT	PART NO. WF2013-TPSNXX	WCON Http: www.wcon.com	
				x.x	±0.30			UNIT	mm			
				x.xx	±0.25	CHECK Morris	DATE 2023/03/06	SIZE	A4	TITLE: 2.0mm HOUSING Termina, J Type Crimp Type.		
				x.xxx	±0.15			SHEET	1/1			
AO	2023/03/06	NEW	---	Angle	±3°	APPROVE	DATE	SHEET	1/1	Customer NO.	WCON-Dongguan Tel: +86 769 85358920 Fax: +86 769 85358915 E-mail: sales@wcon.com	WCON-Kunshan Tel: +86 512 57468408 Fax: +86 512 57468468 E-mail: salesk@wcon.com
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL	---	---	PROJ.				